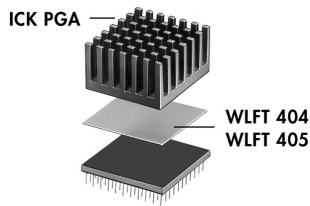




EN: This Datasheet/Document is presented by the manufacturer.

Please visit our website for pricing and availability at www.hestore.hu.

Data sheet Product ICK PGA 21 x 21

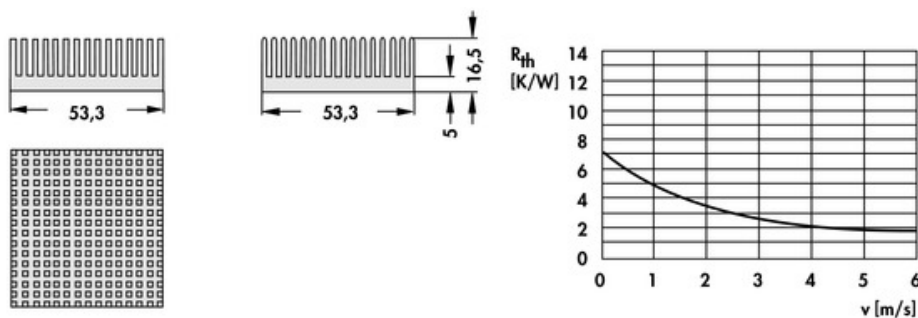


Heatsinks and active heatsinks for processors>Heatsinks for PGA
53,3 x 53,3 x 16,5 mm, for IC design PGA and others

Features

way of fixation:	• therm. conductive foil • therm. cond. adhesive
socket:	universal
suitable for processor type:	universal
width:	53.34 mm
height:	16.51 mm
plate thickness:	5 mm
length:	53.34 mm
thermal resistance:	7 - 1.9 K/W
dissipation loss:	8.6 W
surface:	black anodised

Technical Drawing



Fischer Elektronik GmbH & Co. KG
DEUTSCHLAND • GERMANY • ALLEMAGNE

Nottebohmstraße 28
58511 Lüdenscheid

Telefon +49 2351 435-0
Telefax +49 2351 45754

info@fischerelektronik.de
www.fischerelektronik.de